

LINEAR TECHNOLOGY MATERIALS DECLARATION

(Engineering Calculation)

QFN 3mm X 3mm Exp. Pad

LT3755IU-D-2#TRPBF

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TOTAL MASS (g): 0.023009

COMPONENT MATERIAL	VENDOR/INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL Pkg.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.000062	1000000	27463.9921875		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.008752	975000	38076.84375		
		Iron (Fe)	7439-89-6	0.000215	24000	9344.26660156		
		Phosphorus (P)	7723-14-0	0.000003	300	130.385131836		
		Zinc (Zn)	7440-66-6	0.000006	700	260.770203672		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		<b>Lead Frame Total:</b>				<b>0.008976</b>	<b>1000000</b>	<b>390112.3125</b>
		Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0
Exter. Plating Sn	7440-31-5			0.000413	1000000	17939.3066406		
<b>External Plating Total:</b>						<b>0.000413</b>	<b>1000000</b>	<b>17939.3066406</b>
Inter. Plating Ni	7440-02-0			0.000000	0	0		
Inter. Plating Ag	7440-22-4			0.000203	1000000	8822.7265625		
<b>Internal Plating Total:</b>						<b>0.000203</b>	<b>1000000</b>	<b>8822.7265625</b>
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000518	750000	22513.1640625		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000173	250000	7518.875		
		<b>Die Attach Total:</b>				<b>0.000691</b>	<b>1000000</b>	<b>30032.0140156</b>
		Encapsulation	MULTIAROMATIC RESIN BOND FREE	Resin (EP)		0.001534	130000	66670.2578125
Bromine (Br)	40093-93-8			0.000000	0	0		
Silica (SiO2)	60676-86-0			0.010148	860000	441049.40625		
Antimony Trioxide (Sb2O3)	1309-64-4			0.000000	0	0		
Metal Hydroxide				0.000000	0	0		
Carbon Black (C)	1333-86-4			0.000118	10000	5128.48144531		
<b>Encapsulation Total:</b>						<b>0.011800</b>	<b>1000000</b>	<b>512848.125</b>
Bond Wire Estimated	AFW/TANAKA/Kn	Gold (Au)	7440-57-5	0.000064	1000000	2781.54931641		

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